Serial No. 10/747,723 Response to QA dated 10/25/05

IN THE CLAIMS:

- 1-3. (Canceled)
- 4. (Currently Amended) A method of operating a CMP system, comprising: obtaining a sensor signal from an electric drive assembly driving a pad conditioner of said CMP system; [[and]] estimating a condition of said pad conditioner on the basis of said sensor signal; and predicting a remaining lifetime of the conditioning surface of said pad conditioner on the basis of the estimated condition.
- 5. (Original) The method of claim 4, wherein said sensor signal is indicative of at least one of a revolution of at least one electric motor of said drive assembly and a torque of said at least one motor.
- 6. (Original) The method of claim 5, wherein estimating said condition of said pad conditioner includes:
 - establishing reference data for at least one characteristic of said pad conditioner; and comparing said sensor signal with said reference data.
- 7. (Original) The method of claim 6, wherein said at least one characteristic includes a frictional force acting between a conditioning surface of said pad conditioner and a polishing pad during operation of said CMP system.

DIRING

Serial No. 10/747,723 Response to OA dated 10/25/05

8. (Canceled)

- 9. (Original) The method of claim 4, further comprising controlling operation of said CMP system on the basis of said sensor signal.
- 10. (Original) The method of claim 9, wherein controlling operation of said CMP system includes readjusting at least one of a downforce, a polish time and a relative speed between a substrate and a polishing pad on the basis of said sensor signal.
- 11. (Original) The method of claim 9, wherein controlling operation of said CMP system includes readjusting a drive signal to said drive assembly on the basis of said sensor signal to adjust a conditioning effect.
- 12. (Currently Amended) A method of controlling a process sequence including a CMP process, comprising:
 - obtaining a signal from a conditioner drive assembly of a CMP system, said signal being indicative of at least one of a motor torque and a speed of a motor of said drive assembly; [[and]]
 - adjusting at least one process parameter in said process sequence on the basis of said signal; and
 - estimating a remaining lifetime of at least one consumable component of said CMP system on the basis of said signal.

01/11/2006 09:28 2624323885 DIRING PAGE 05/10

Serial No. 10/747,723 Response to OA dated 10/25/05

13. (Original) The method of claim 12, wherein said at least one process parameter

includes at least one of a downforce, a polish time and relative speed of a pad and a polishing

head in said CMP system.

14. (Original) The method of claim 12, wherein said at least one process parameter

includes a deposition specific parameter of a deposition tool arranged upstream of said CMP

system.

15-21. (Canceled)